

# **Mek PowerSpector Inline**

# Inline AOI System For SMT + THT Components And Solder Joints



### Inline AOI System For SMT + THT Components And Solder Joints



## Benefits

→ Revolutionary Selective 3D Laser Measurement Technology

Selective height measurement of any given object. Assign two points, a reference and a target.

- → Newest Generation 5MP USB 3 Vision Cameras The latest generation of high speed, high quality cameras. No capture card requirement.
- → Multi-color 4 angle lighting with Line Source Coaxial Lighting and Meniscus Profiler Reliable solder joint meniscus and pad surface analysis to find solder and paste printing defects.
- → Flexible Classification And Reporting Scenarios Integrate AOI efficiently in existing operations and factory layout.
- → Compatible With Mek Catch System For MES Gateways, Repair, Real Time Monitoring And SPC Catch System is compatible with Windows 11 and is a complete suite for data collection, display and statistics. (optional CFX or iTac compatibility)
- → Line Sourced DOAL (Direct On Axis Lighting) Coaxial Lighting

Inspect solder joints without shadow effects from tall components nearby.



Using modern processor and storage power for parallel imaging, calculation and data transmission.

→ High Resolution Telecentric Optics Standard 15µ resolution for optimal magnification of smaller SMT component package sizes.

### → 8x Angular Cameras

Triple use of the angular cameras: Automatic inspection, defect classification and repair post-inspection.

### → Z-Axis Moving Optical Unit

Focus and position optimally for variying PCB and component distances, warpage or sandwitch assemblies.

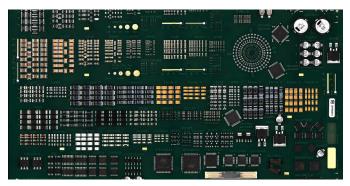
- → Automatic Conveyor Width Adjustment Each program has a parameter for the conveyor width. When the program is loaded, the conveyor width is set automatically, using the stepper motor driven width adjustment.
- → Synthetic Imaging And Spectral Analysis Powerful algorithms to achieve optimized inspection results.





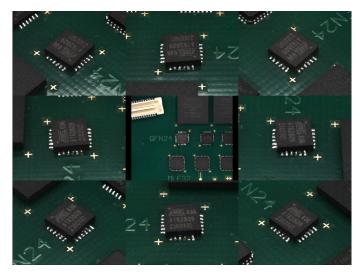
### Inline AOI System For SMT + THT Components And Solder Joints

### **Features**



→ High Definition Images

The large frame camera CCD and the high quality lenses combination result in crisp and high definition images.



### → 8x Angular Cameras

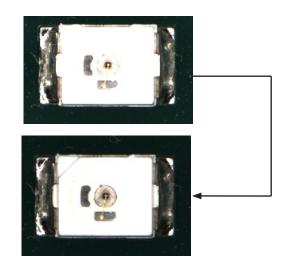
Triple use of the angular cameras: Automatic inspection, defect classification and repair post-inspection.



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 → 01005" Components Inspectable
High camera and lens resolution make inspection down to 01005" components possible.



→ Dynamic Light Reduction And Increase Dynamically adjust light intensity to analyse details on white/ black PCB's or white/black components.



### Inline AOI System For SMT + THT Components And Solder Joints

### Features



#### → Selective 3D Laser Measurement Measure heights of any given object. Simply assign two points, a reference and a target. Rapid measurement that only extends the cycle time slightly.



 $\rightarrow~$  Z-Axis Moving Optical Unit

Ability to focus and position the optics optimally for best inspection results.

# Defect Types (not limited to)



Presence/Absence



 $\rightarrow$  Text (OCV and OCR)

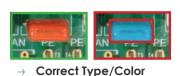


 $\rightarrow \ \ \text{Polarity}$ 

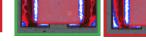


 $\rightarrow$  Bridges







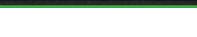


 $\rightarrow$  Billboarding



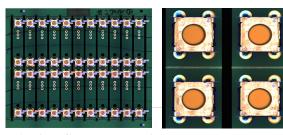
Correct Type/Value/Color







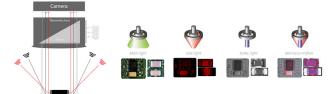
because inspection matters



→ Coplanarity Measurement There is no limit of how many points.

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There is no limit of how many points can have the laser height measurement. Coplanarity of components can be measured in both horizontal and vertical directions.



#### → Meniscus Profiler

Coaxial and omnidirectional lighting from different angles and with different colors to make solder defects visible.



# Specifications Inline PowerSpector JSAz

Characteristics	PowerSpector JSAz 350L	PowerSpector JSAz 650L
Product Type	SMT And THT Components And Solder Joints AOI	
Maximum PCB Size	350x250mm (13.8"x9.8")	650x550mm (25.7"x21.7")
Camera Movement	X + Y + Z Direction	
PCB Movement	Stationary	
Parts Inspection	Components Height, Coplanarity, Presence, Polarity, Solder Meniscus, Shape, Offset, Text	
Image Processing	Synthetic Imaging, Spectral Analysis, HSB, Grescale/RGB Limits	
Camera Type	5 MP CCD Camera With USB3 Vision	
Camera Field of View/Resolution	36 x 30mm (1.42" x 1.18") / 15.0 µm (14.4 x 12mm / 6µm option)	
Lens	Telecentric lens with built in prism for DOAL Lighting	
Selective Height Measurement	Laser Projector, Triangular spot measurement	
Lighting System	Omnidirectional Quad LED rings: Side White, Side Red, Main, Line Sourced DOAL Diffused On Axis Lighting	
System Specifications		
Minimum Inspection Component Size	01005" (0.4 x 0.2mm) (6µm lens upgrade option)	
Component Clearance (Top)	60mm (2.4")	
Component Clearance (Bottom)	35mm (1.38") or 55mm (2.17") Without PCB Support Lift Option	
Side Cameras	8x Digital Color USB 3.0 Vision in 45/45 Orientation	
Max Measurable Height	30mm	
Height Measurement Resolution	30µm	
Z-Axis Stroke	30mm (1.2")	
Inspection Speed Typical	0.6 sec per FoV	
Electrical Requirements	100-240 VAC /150W	
Interfacing		
Control PC Type	Apple MacOS	
Data Interface	USB	
Programming Interface	CSV Centroid placement file, (ODB++, Gerber Option)	
Repair/Monitor/SPC System/MES-interface	Mek Catch System (Windows 7/8/10/11) (Option)	
	Enterprise SQL DB/XML Files/Socket (Catch System Option)	
3rd Party Interfacing (MES) & Data Storage		Scker (Carch system Option)
Conveyor		
Conveyor Belt Speed	10-500mm/s (0.4-19.7"/s)	
Conveyor Configuration	Left>Right (optional Right>Left), Front Rail Fixed, Height 830-950mm	
PCB Clamping	Top Justified, Ruler Blade, Top & Edge Clamping, Sensor Stopper (3mm edge clearance)	
Minimum Board Size	50x50mm (2.0" x 2.0")	
PCB Warpage Compensation	Automatic PCB Support Lift With Magnetic Pins (Option)	
General		
Operating Temperature	15-30 deg. C(60-90 deg. F)	
Operating Humidity	15-80 % RH	
External Size	W770x D846 x H1300	W1070 x D1106 x H1330
	(30.3" x 33.3" x 51.2")	(42.1" x 43.5" x 52.3")
Weight	180kg (397lbs)	280kg (617lbs)



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